

fastrax division



pho**tronix**

technical data

Layers	1 to 14
Maximum thickness	7.0mm
Materials	FR-4, Halogen-free, HI TG, Rogers, Arlon, Nelco, ISOLA 370HR
Minimum width/spacing	Inner layer 3.5 mil/4 mil (Hoz). Outer layer 3.5 mil/4 mil (Hoz)
Maximum copper thickness	4 oz Cu
Minimum hole size	6 mil (0.15mm) mechanical drill, 0.1mm laser drill
Maximum panel size	600 x 1000 mm
Surface finishes	HASL, Immersion tin, OSP, Immersion silver, Gold finger and Immersion gold

A rapid response for prototypes, small batch and sample printed circuit boards. These are manufactured in China, providing high quality boards at very competitive prices. Including our advanced technologies such as Plated & Filled Via Holes (POFV), Laser Drilling and HDI capability place us at the forefront of PCB manufacturing.

- Delivery of 2-4 layers from 5 working days.
- Delivery of 6-8 layers from 7 working days.
- Delivery of 10-14 layers from 10 working days.

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